Application Data Sheet APPLICATION INFORMATION

Secrecy Order in Parent Appl.?:: No

| Application Number:: | |
|----------------------------------|-------------------------------------|
| Filing Date:: | |
| Application Type:: | Regular |
| Subject Matter:: | Utility |
| Suggested classification:: | |
| Suggested Group Art Unit:: | |
| CD-ROM or CD-R?:: | None |
| Number of CD Disks: | |
| Number of Copies of CDs:: | |
| Sequence Submission?:: | |
| Computer Readable From (CRF) | ?:: No |
| Number of Copies of CRF:: | |
| Title:: | SEMICONDUCTOR DEVICE WITH CUPPER |
| | WIRING AND METHOD FOR MANUFACTURING |
| | SEMICONDUCTOR DEVICE |
| Attorney Docket Number:: | 402913 |
| Request for Early Publication?:: | No |
| Request for Non-Publication?:: | No |
| Suggested Drawing Figure:: | |
| Total Drawing Sheets:: | 2 |
| Small Entity?:: | No |
| Latin Name:: | |
| Variety denomination name:: | |
| Petition Included?:: | No |
| Petition Type:: | |
| Licensed US Govt. Agency:: | |
| Contract or Grant Numbers:: | |

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APPLICANT INFORMATION

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Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Naruhiko

Middle Name::

Family Name:: KAJI

Name Suffix::

State or Prov. of Residence::

City of Residence::

Country of Residence:: Japan

Street of mailing address:: c/o Semiconductor Leading Edge

Technologies, Inc.

16-1 Onogawa

City of mailing address:: Tsukuba-shi

State or Province of mailing address:: Ibaraki

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 305-8569

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548

Phone:: (202) 737-6770

Fax:: (202) 737-6776

E-mail Address:: dcmail2@leydig.com

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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country:: Application Number:: Filing Date:: Priority Claimed

Japan 2002-363396 12/16/02 Yes

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ASSIGNEE INFORMATION

Assignee name:: Semiconductor Leading Edge Technologies, Inc.

Street of mailing address:: 16-1 Onogawa

City of mailing address:: Tsukuba-shi

State or Province of

mailing address:: Ibaraki

Country of mailing

address:: Japan

Postal or Zip Code of

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